Our Ref.: 62013 - P034

DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below, next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first an joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

FLIP-CHIP-BONDED OPTICAL MODULE PACKAGE AND METHOD OF PACKAGING OPTICAL MODULE USING FLIP CHIP BONDING

the specification of	which	•			
V_is attached	hereto.				
was filed on as					
	Application Serial No				•
and was amended on					
(if applicable)					
believe that the sa thereof, or patented more than one year United States of A been patented or min any country fore	I have reviewed and s, as amended by any me was ever known or described in any par prior to this applica merica more than one hade the subject of an eign to the United Stassigns more than twelves.	y amendment referred or used in the Unite or used in the Unite or tion, that the same a year prior to this a inventor's certificate ates of America on	I to above. I do I states of Ame In country before I was not in public I pplication, ant the I issued before the I an application fi	to not know a crica before m e my invention c use or on a at the invention	and do not y invention ther of or sale in the on has not
I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).					
application(s) for ba	ign priority benefits un tent or invertor's certif nt or inventor's certifica	icate listed below an	id have also idei	ntified helow s	any foreign
Prior Foreign Application(s)			Priority <u>Claimed</u>		
01-74952	Rep. of Korea	29/Novemb	per/2001	v	
(Number)	(Country)	(Day/Monti	n/Year Filed)	Yes	No
(Number)	(Country)	(Day/Month	n/Year Filed)	Yes	No
(Number)	(Country)	(Day/Month	n/Year Filed)	Yes	No
I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filling date of the prior application and the national or PCT international filling date of this application: (Application Serial No.) (Filling Date) (Status patented,					
	,	(. mig Dato)	•	abandoned)	
(Application S	erial No.)	(Filing Date)	(Status pending, a	patented, abandoned)	

I hereby appoint BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN, a firm including: Bradley J. Bereznak, revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such wilful false statements may jeopardize the validity of the application or any patent issued thereon.

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